

STW8N90K5

N-channel 900 V, 0.60 Ω typ., 8 A MDmesh™ K5 Power MOSFET in a TO-247 package

Datasheet - production data

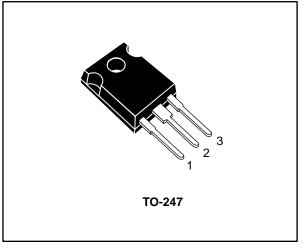
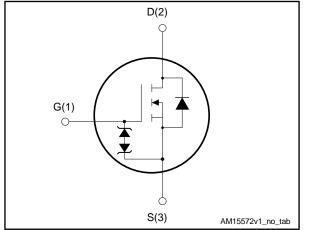


Figure 1: Internal schematic diagram



Features

Order code	VDS	R _{DS(on)} max.	ID
STW8N90K5	900 V	0.68 Ω	8 A

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing	
STW8N90K5	8N90K5	TO-247	Tube	

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±30	V
ID ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	8	А
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	5	А
ID ⁽²⁾	Drain current pulsed		А
P _{TOT}	Total dissipation at T_C = 25 °C	130	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	4.5	
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	V/ns
TJ	Operating junction temperature range	55 to 150	°C
T _{stg}	Storage temperature range	-55 to 150	

Notes:

⁽¹⁾Limited by maximum junction temperature.

 $^{(2)}\mbox{Pulse}$ width limited by safe operating area

 $^{(3)}I_{SD} \leq 8$ A, di/dt \leq 100 A/µs; V_Ds peak \leq V(BR)DSS

 $^{(4)}V_{DS} \le 720 \text{ V}$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	0.96	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_J max)	2.7	А
Eas	Single pulse avalanche energy (starting $T_J = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	250	mJ



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Table 5: On/off-state								
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
V(BR)DSS	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	900			V		
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 900 V$			1	μA		
		$V_{GS} = 0 V, V_{DS} = 900 V,$ T _c = 125 °C ⁽¹⁾			50	μA		
I _{GSS}	Gate body leakage current	$V_{DS}=0~V,~V_{GS}=\pm20~V$			±10	μA		
V _{GS(th)}	Gate threshold voltage	$V_{\text{DS}} = V_{\text{GS}}, \ I_{\text{D}} = 100 \ \mu\text{A}$	3	4	5	V		
R _{DS(on)}	Static drain-source on-resistance	V_{GS} = 10 V, I_D = 4 A		0.60	0.68	Ω		

Table 5: On/off-state

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Symbol Parameter Test conditions Min. Typ. Max. Unit								
Symbol	Falailletei	rest conditions	IVIIII.	тур.		Unit			
Ciss	Input capacitance		-	426	-	pF			
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	41	-	pF			
Crss	Reverse transfer capacitance		-	1.2	-	pF			
Co(tr) ⁽¹⁾	Equivalent capacitance time related	V _{DS} = 0 to 720 V,	-	75	-	рF			
$C_{o(er)}^{(2)}$	Equivalent capacitance energy related	$V_{GS} = 0 V$	-	28	-	pF			
Rg	Intrinsic gate resistance	f = 1 MHz , I _D = 0 A	-	7	-	Ω			
Qg	Total gate charge	$V_{DD} = 720 \text{ V}, \text{ I}_{D} = 8 \text{ A},$	-	11	-	nC			
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	3.5	-	nC			
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	4.8	-	nC			

Table 6: Dynamic

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}

 $^{(2)}\mathsf{E}\mathsf{nergy}$ related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_Ds increases from 0 to 80% V_Dss



Electrical characteristics

	Table 7: Switching times								
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit			
t _{d(on)}	Turn-on delay time	V _{DD} = 450 V, I _D = 4 A,	-	14.7	-	ns			
tr	Rise time	$ \begin{array}{l} R_{G} = 4.7 \; \Omega, \; V_{GS} = 10 \; V \\ (see \ \textit{Figure 14: "Test circuit for resistive load switching times" \\ and \ \textit{Figure 19: "Switching time waveform" \\ \end{array} $	-	13.2	-	ns			
t _{d(off)}	Turn-off delay time		-	36.4	-	ns			
t _f	Fall time		-	13.5	-	ns			

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		8	А
Isdm ⁽¹⁾	Source-drain current (pulsed)		-		32	А
Vsd ⁽²⁾	Forward on voltage	$I_{SD} = 8 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.5	V
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	371		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 V$	-	4.27		μC
I _{RRM}	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	23		A
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	582		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 ^{\circ}\text{C}$	-	5.73		μC
Irrm	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	19.7		A

Notes:

⁽¹⁾Pulse width limited by safe operating area

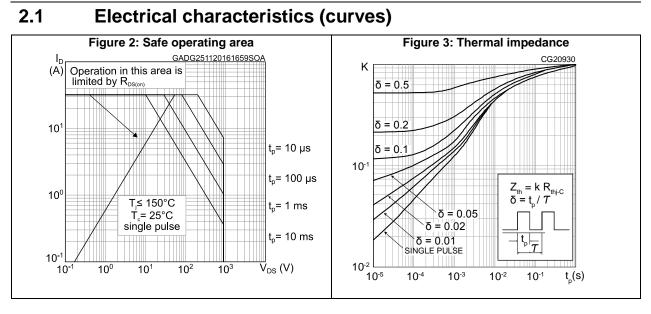
 $^{(2)}$ Pulsed: pulse duration = 300 µs, duty cycle 1.5%

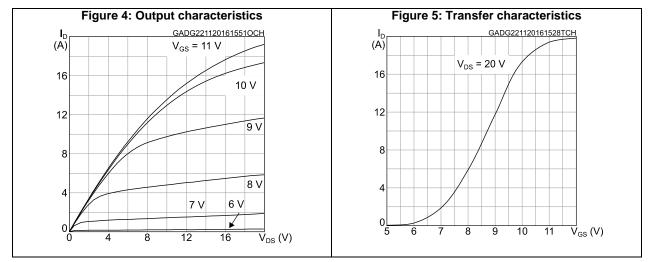
Table 9:	Gate-source	Zener	diode
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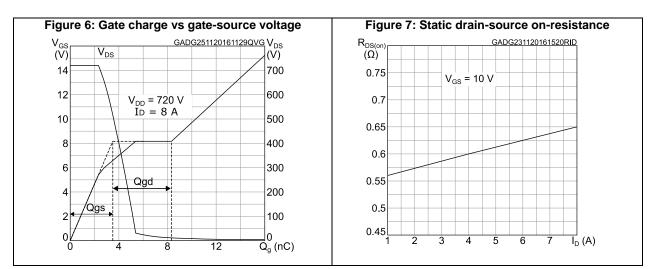
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V (BR)GSO	Gate-source breakdown voltage	$I_{GS}=\pm 1$ mA, $I_{D}=0$ A	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.









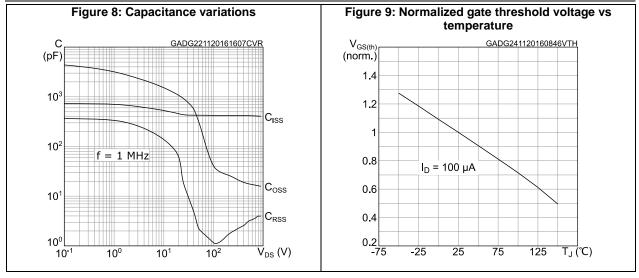
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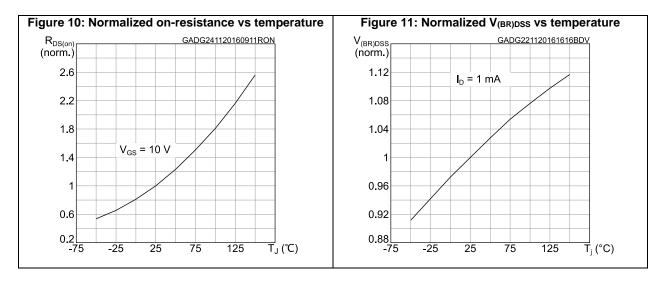


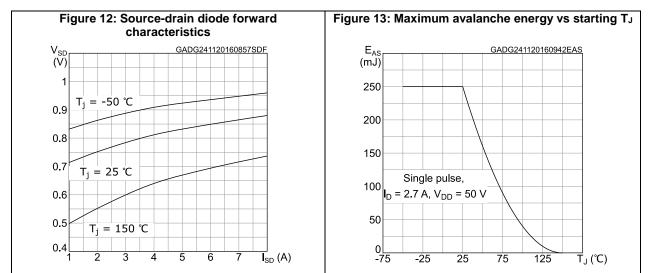
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Electrical characteristics

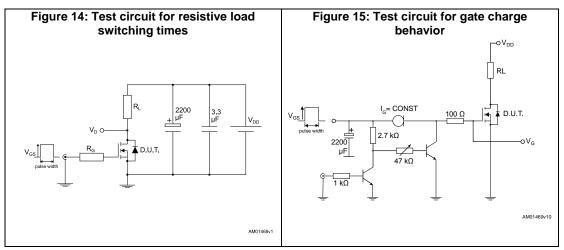


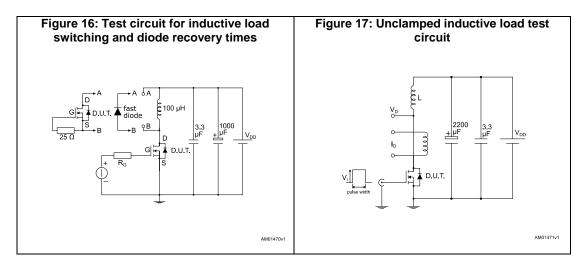


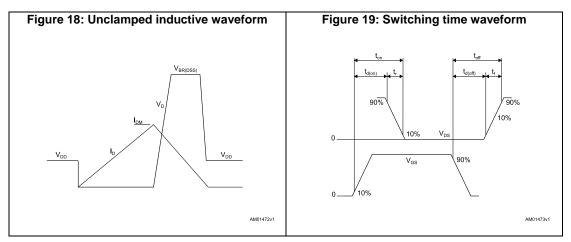


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3 Test circuits







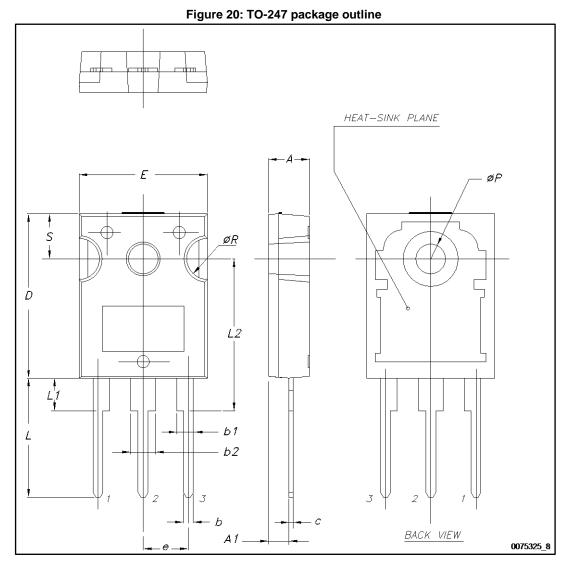
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information



Package information

Table 10: TO-247 package mechanical data

STW8N90K5

Table 10: 10-247 package mechanical data				
Dim.	mm			
	Min.	Тур.	Max.	
A	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	



5 Revision history

Table 11: Document revision history

Date	Revision	Changes
28-Nov-2016	1	First release



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